

Part Number: SA30-21GWA

Green

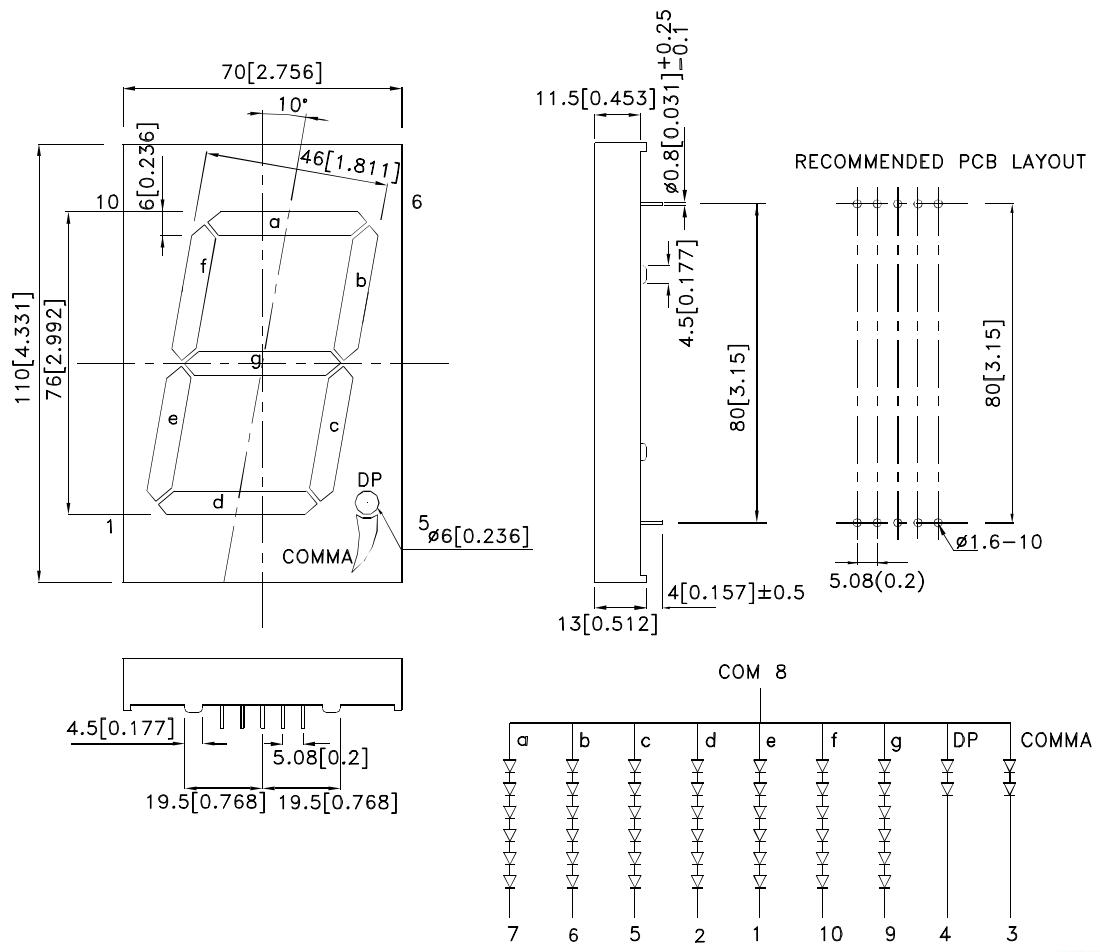
### Features

- 3.0 inch digit height.
- Low current operation.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Categorized for luminous intensity.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

### Description

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

### Package Dimensions & Internal Circuit Diagram



Notes:

1. All dimensions are in millimeters (inches), Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

## Selection Guide

Part No.	Dice	Lens Type	I <sub>v</sub> (mcd) [1] @ 10mA		Description
			Min.	Typ.	
SA30-21GWA	Green (GaP)	White Diffused	21	52	Common Anode ,Rt. Hand Decimal.
			*5.6	*16	

Notes:

1. Luminous intensity/ luminous Flux: +/-15%.

\*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
$\lambda_{peak}$	Peak Wavelength	Green	565		nm	I <sub>f</sub> =20mA
$\lambda_D$ [1]	Dominant Wavelength	Green	568		nm	I <sub>f</sub> =20mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Green	30		nm	I <sub>f</sub> =20mA
C	Capacitance	Green	15		pF	V <sub>f</sub> =0V;f=1MHz
V <sub>F</sub> [2]	Forward Voltage Per segment or(Dp and Comma)	Green	13.2 (4.4)	15.0 (5.0)	V	I <sub>f</sub> =20mA
I <sub>R</sub>	Reverse Current Per segment or(Dp and Comma)	Green		10 (10)	uA	V <sub>R</sub> = 5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

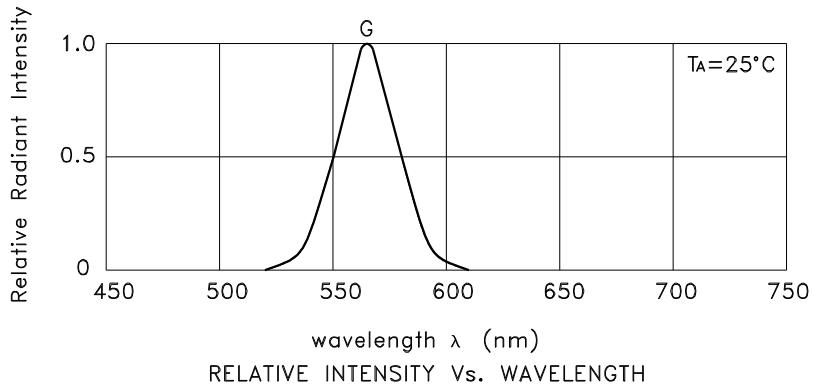
## Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units
Power dissipation Per segment or(Dp and Comma)	375 (125)	mW
DC Forward Current Per segment or(Dp and Comma)	25 (25)	mA
Peak Forward Current [1] Per segment or(Dp and Comma)	140 (140)	mA
Reverse Voltage Per segment or(Dp and Comma)	5 (5)	V
Operating / Storage Temperature	-40°C To +85°C	
Lead Solder Temperature[2]	260°C For 3-5 Seconds	

Notes:

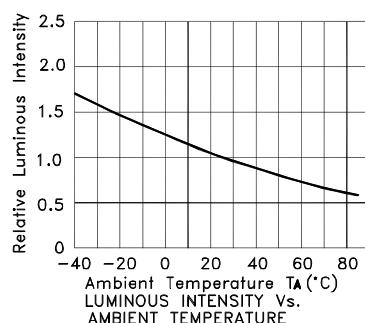
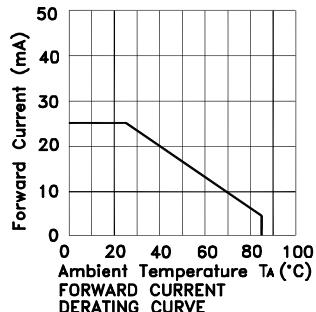
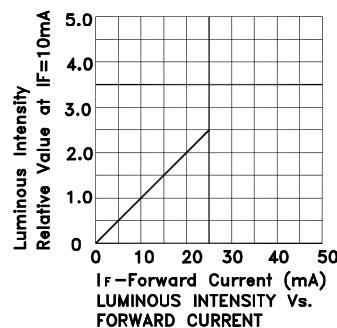
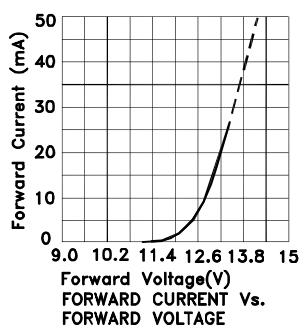
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

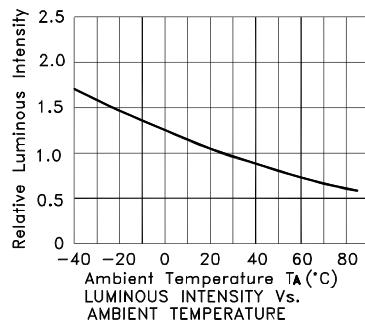
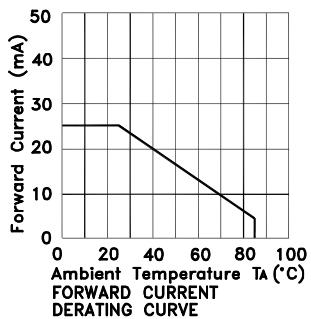
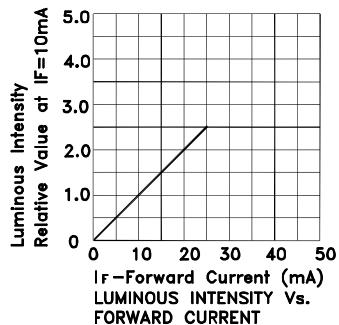
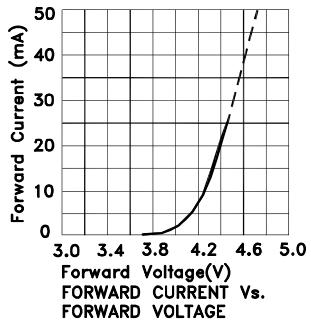
2. 2mm below package base.



Green

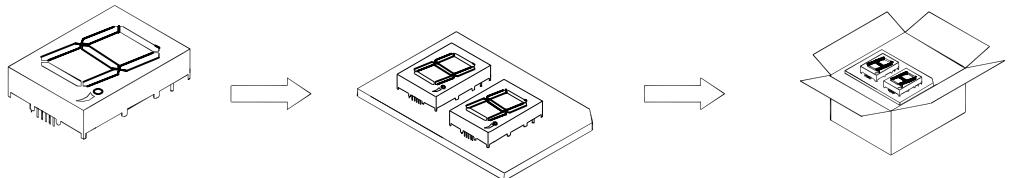
SA30-21GWA



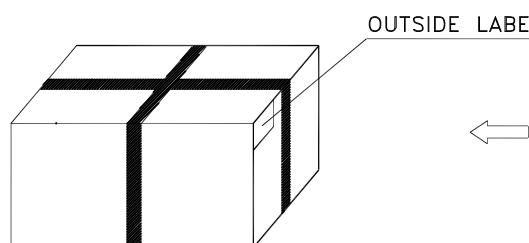


## PACKING & LABEL SPECIFICATIONS

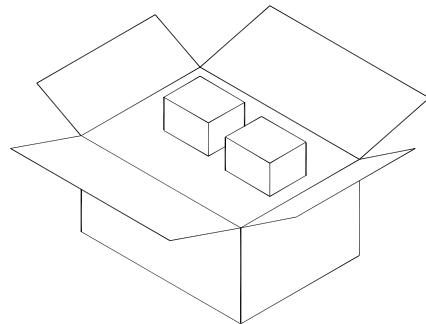
SA30-21GWA



8PCS/1# BOX

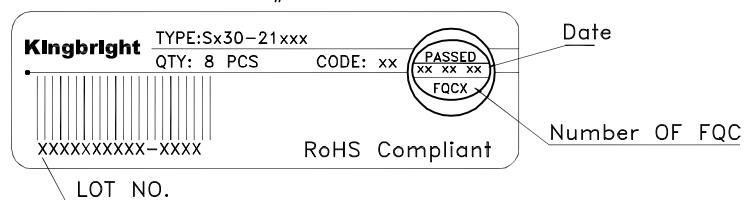


64PCS/BOX

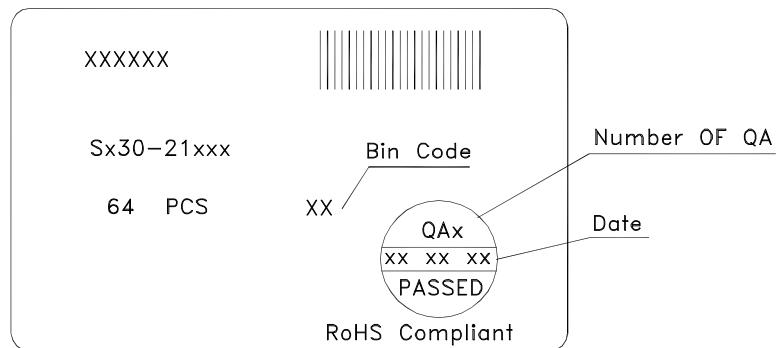


8(1#) BOX/9# BOX

Inside Label On 1#BOX



Outside Label On Box

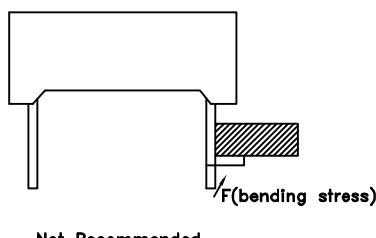


## THROUGH HOLE DISPLAY MOUNTING METHOD

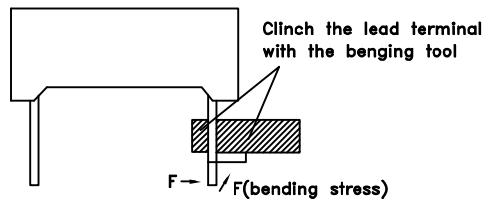
### Lead Forming

Do not bend the component leads by hand without proper tools.

The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.



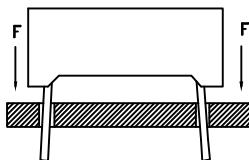
Not Recommended



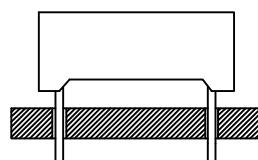
Recommended

### Installation

1. The installation process should not apply stress to the lead terminals.
2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

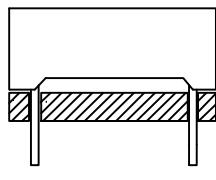


Not Recommended

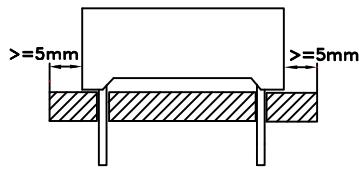


Recommended

3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



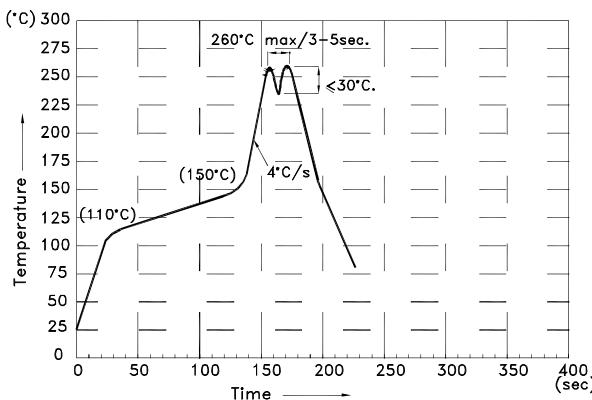
Not Recommended



Recommended

## DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



### NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering , the PCB top-surface temperature should be kept below 105°C
5. No more than once.

## Soldering General Notes:

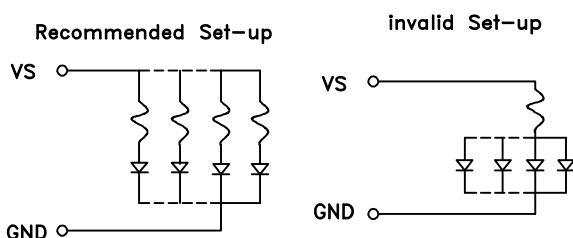
1. Through-hole displays are incompatible with reflow soldering.
2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

## CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

## CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



Detailed application notes are listed on our website.  
[http://www.kingbright.com/application\\_notes](http://www.kingbright.com/application_notes)